2SK2352

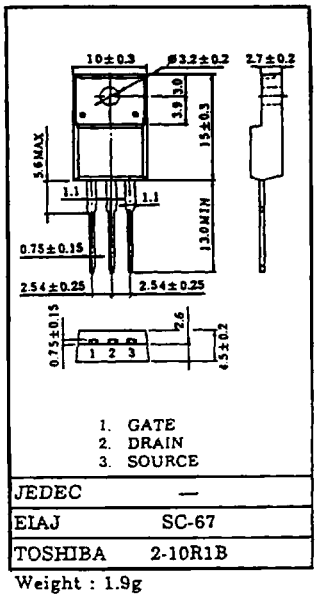
Field Effect Transistor

Silicon N Channel MOS Type (π-MOS IV)

High Speed, High Current Switching, DC-DC Converter

Chopper Regulator and Motor Drive Applications

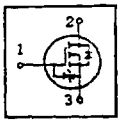
Unit in mm



1. GATE
2. DRAIN
3. SOURCE

JEDEC	—
EIAJ	SC-67
TOSHIBA	2-10R1B

Weight : 1.9g



Features

- 4V Gate Drive
- Low Drain-Source ON Resistance
  - $R_{DS(ON)}$ = 1.06Ω (Typ.)
- High Forward Transfer Admittance
  - $|Y_{fs}|$ = 6S (Typ.)
- Low Leakage Current
  - I_{DSS} = 100μA (Max.) @ V_{DS} = 600V
- Enhancement-Mode
  - V_{th} = 2.0 ~ 4.0V @ V_{DS} = 10V, I_D = 1mA

Absolute Maximum Ratings (Ta = 25°C)

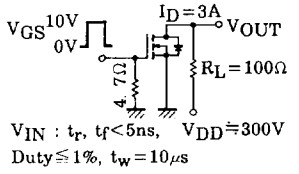
CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Drain-Gate Voltage (R_{GS} = 20kΩ)		V_{DGR}	600	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	DC	I_D	6	A
	Pulse	I_{DP}	24	
Drain Power Dissipation (Tc = 25°C)		P_D	45	W
Channel Temperature		T_{ch}	150	°C
Storage Temperature Range		T_{stg}	-55 ~ 150	°C

Thermal Characteristics

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	1.25	°C/W
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	83.3	°C/W

This transister is an electrostatic sensitive device. Please handle with caution.

Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	V_{GS} = ±25V, V_{DS} = 0V	–	–	±10	μA
Gate-Source Breakdown Voltage		$V_{(BR)GSS}$	I_G = ±100μA, V_{DS} = 0V	±30	–	–	V
Drain Cut-off Current		I_{DSS}	V_{DS} = 600V, V_{GS} = 0V	–	–	100	μA
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	I_D = 10mA, V_{GS} = 0V	600	–	–	V
Gate Threshold Voltage		V_{th}	V_{DS} = 10V, I_D = 1mA	2.0	–	4.0	V
Drain-Source ON Resistance		$R_{DS\ (ON)}$	V_{GS} = 10V, I_D = 3A	–	1.06	1.25	Ω
Forward Transfer Admittance		$\|Y_{fs}\|$	V_{DS} = 10V, I_{DS} = 3A	4.0	6.0	–	S
Input Capacitance		C_{iss}	V_{DS} = 10V, V_{GS} = 0V, f = 1MHz	–	1250	–	pF
Reverse Transfer Capacitance		C_{rss}		–	75	–	
Output Capacitance		C_{oss}		–	320	–	
Switching Time	Rise Time	t_r		–	14	–	ns
	Turn-on Time	t_{on}		–	35	–	
	Fall Time	t_f		–	12	–	
	Turn-off Time	t_{off}		–	65	–	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	V_{DD} = 400V, V_{GS} = 10V, I_D = 6A	–	30	–	nC
Gate-Source Charge		Q_{gs}		–	18	–	
Gate-Drain ("Miller") Charge		Q_{gd}		–	12	–	

Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	–	–	–	6	A
Pulse Drain Reverse Current	I_{DRP}	–	–	–	24	A
Diode Forward Voltage	V_{DSF}	I_{DR} = 6A, V_{GS} = 0V	–	–	1.8	V
Reverse Recovery Time	t_{rr}	I_{DR} = 6A, V_{GS} = 0V, dI_{DR}/dt = 100A/μs	–	–	–	ns
Reverse Recovered Charge	Q_{rr}		–	–	–	μC